

sub 1 screen printing a suitable ink into the channels or openings to a desired thickness.

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Cancel claim 8.

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Claim 9 line 1, delete "7" and substitute --8--

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sub 2 9 (Amended). A method of making buried passive components comprising

- B<sup>2</sup>
- a) embossing an opening of a desired shape and size directly on the surface of [in] a green tape;
  - b) filling said opening by screen printing with an ink including said component material;
  - c) burying said green tape in a green tape stack;
  - d) aligning and laminating said stack onto a metal support board coated with a low melt temperature glass; and
  - e) firing said stack to remove organic materials and to densify the glass of the green tape.
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REMARKS

The claims are 1-11. Applicants have amended the claims to provide that embossing occurs directly on the surface of the green tape, with no intermediate polymer layer between the surface of the green tape and the embossing tool.

The claims are directed to making lines and openings in a